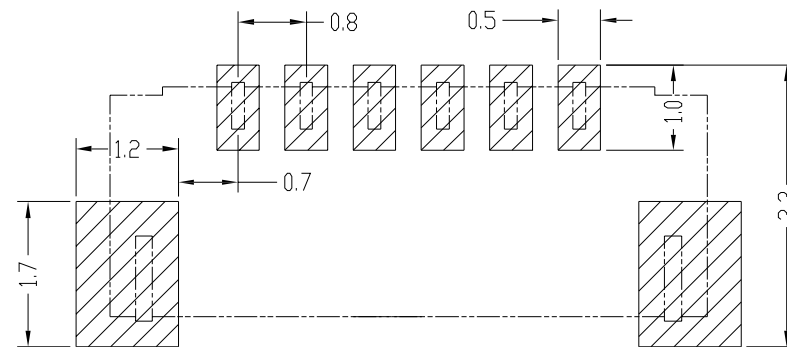
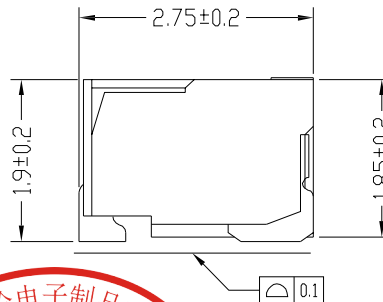
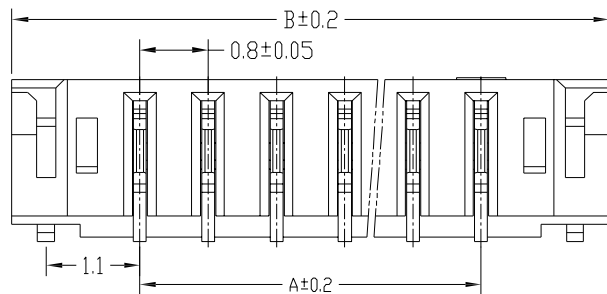
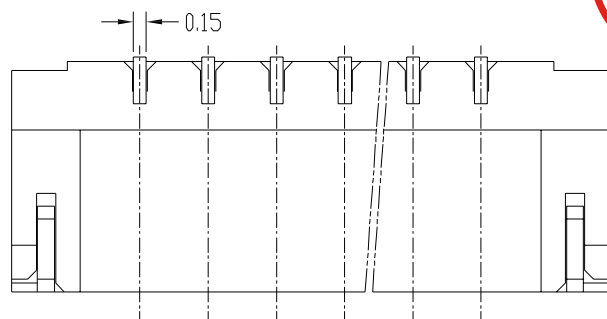




PCB LAYOUT



15	11.2	14.2			
14	10.4	13.4			
13	9.6	12.6			
12	8.8	11.8			
11	8.0	11.0	25	19.0	22.0
10	7.2	10.2	24	18.2	21.2
9	6.4	9.4	23	17.4	20.4
8	5.6	8.6	22	16.6	19.6
7	4.8	7.8	21	15.8	18.8
6	4.0	7.0	20	15.0	18.0
5	3.2	6.2	19	14.2	17.2
4	2.4	5.4	18	13.4	16.4
3	1.6	4.6	17	12.8	15.8
2	0.8	3.8	16	12.0	15.0
孔位	DIM A	DIM B	孔位	DIM A	DIM B

主要技术参数 Main Specifications

线 数 (Poles): 02 to 25

接触电阻 (Contact resistance): $\leq 20m\Omega$

绝缘电阻 (Insulation resistance): $\geq 100M\Omega$

额定电压 (Rated voltage): 30V AC DC

额定电流 (Rated current): 0.5A AC DC

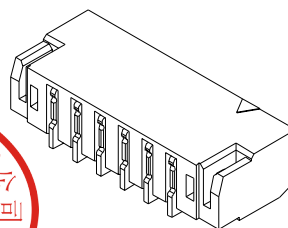
耐 电 压 (Withstand Voltage): 200V AC/minute

温度范围 (Temperature Range): $-25^{\circ}C \sim +85^{\circ}C$

ORDER INFORMATION:

PART No.	A0801AWR-**-F4M*1-*	PACKAGING:	R=REEL
No.OF CIRCUITS:	02~25	P=PE	
PLASTIC MATERIAL:	F4M=LCP(BEIGE)	Metal code:	1=PhosphorBronze
		PLATING:	B=MATTE Sn
		C=GOLD	

C	Solder TAB	2 PCS	PhosphorBronze	Matte Sn-plated
B	CONTACT	n PCS	PhosphorBronze	Matte Sn-plated/GOLD
A	HOUSING	1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH



UNITS	mm	东莞市朗纶电子制品有限公司		
MAT'L		Dongguan langlun electronic products Co., Ltd		
FINISH		PART NO.(INTENDED USE)	TITLE:	
		A0801AWR-**-F4M*1-*	0.8mmPITCH 90°WAFER SMT TYPE	
Q'TY	PCS	APPD:	DWG NO.:	
		CHKD:	QWY-GCCP-0705	
		DR: HU 2016.09.28		
			SCALE	SHEET
			1/1	1/1
				REV.
				A